Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info: <u>ti.com/support</u>

Form/Declaration Type: Distribute - RoHS and IEC 62474 DB

Created on: **06/08/2022** 

### Details for "TLE2021QDRQ1"

### **Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
TLE2021QDRQ1	NIPDAU	Level-1-260C-UNLIM	TI AGUASCALIENTES	D   8	3.91x4.9x1.58	108.9

### \*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

## **Environmental Ratings Information**

RoHS	REACH	Green	IEC 62474 DB	
Yes	Yes	Yes	Yes	

### **Component Information**

				Homogeneous Material Level		Component Level			
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm		
Bond Wire									
Precious Metals	Gold	7440-57-5	0.055882	100	1000000	0.05131	513		
Sub-Total			0.055882	100	1000000	0.05131	513		
Die Attach Adhesive									
Precious Metals	Silver	7440-22-4	0.341646	79.000053	790001	0.313697	3137		
Thermoplastics	Ероху	85954-11-6	0.090817	20.999947	209999	0.083388	834		
Sub-Total			0.432463	100	1000000	0.397084	3971		
Lead Frame									
Copper and Its Alloys	Copper	7440-50-8	45.74937	97.05	970500	42.006738	420067		
Copper and Its Alloys	Iron	7439-89-6	1.22564	2.6	26000	1.125374	11254		
Copper and Its Alloys	Phosphorus	7723-14-0	0.07071	0.15	1500	0.064925	649		
Zinc and Its Alloys	Zinc	7440-66-6	0.09428	0.2	2000	0.086567	866		
Sub-Total			47.14	100	1000000	43.283604	432836		
Lead Frame Plating									
Nickel and Its Alloys	Nickel	7440-02-0	0.152192	95.12	951200	0.139742	1397		
Precious Metals	Gold	7440-57-5	0.001248	0.78	7800	0.001146	11		
Precious Metals	Palladium	7440-05-3	0.00656	4.1	41000	0.006023	60		
Sub-Total			0.16	100	1000000	0.146911	1469		
Mold Compound									
Other Inorganic Materials	Fused Silica	60676-86-0	52.402765	87.999999	880000	48.115836	481158		
Other Plastics and Rubber	Carbon Black	1333-86-4	0.178646	0.3	3000	0.164031	1640		
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.327517	0.55	5500	0.300724	3007		
Thermoplastics	Ероху	85954-11-6	6.639669	11.150001	111500	6.096496	60965		
Sub-Total			59.548597	100	1000000	54.677087	546771		
Semiconductor Device									
Ceramics / Glass	Doped Silicon	7440-21-3	1.572658	100	1000000	1.444003	14440		
Sub-Total			1.572658	100	1000000	1.444003	14440		
Total			108.9096			100	1000000		

## Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

# Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

# **Product Content Methodology**

For an explanation of the methods used to determine material weights, See Product Content Methodology

# Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

# Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/08/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.